



INFORMATION DISCLOSURE STATEMENT

(Use Several Sheets if necessary)

ATTY DOCKET NO.

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SERIAL NO.

09/879,532

APPLICANT

Stephen M. Hoyles, et al.

FILING DATE

June 12, 2001

GROUP

Unknown 1712

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUB- CLASS	FILING DATE IF APPROPRIATE
11	3,395,118	7/30/68	Reinking et al.	260	47	10/5/66
11	4,438,254	3/20/84	Doorakian et al.	528	89	2/28/83
11	4,480,082	10/30/84	McLean et al.	528	103	7/25/83
11	4,722,990	2/2/88	Koenig et al.	528	95	8/15/85
11	4,981,926	1/1/91	Pham et al.	525	530	2/6/90
11	5,089,588	2/18/92	White et al.	528	99	2/26/91
11	5,109,099	4/28/92	Pham et al.	528	89	8/16/90
11	5,115,075	5/19/92	Brennan et al.	528	99	5/8/90
11	5,171,820	12/15/92	Mang et al.	528	87	5/13/91
11	5,208,317	5/4/93	Pham et al.	528	89	1/31/92
11	5,246,751	9/21/93	White et al.	428	35.4	5/18/92

FOREIGN PATENT DOCUMENTS

DOCUMENT NUMBER	PUBLICATION DATE	COUNTRY	CLASS	SUB- CLASS	TRANSLATION YES NO
EP 0 193 809	9/10/86	Europe	6-08-8	59/02	

OTHER DISCLOSURES (Including Author, Title, Date, Pertinent Pages, Place of Publication, Etc.)

	—EPOXY RESINS AND PROCESS FOR MAKING THE SAME— filed in the United States of America on June 23, 2000.
	Application Serial No. 60/213,965; Applicant: Stephen M. Hoyles, et al.

EXAMINER

ROBERT SELLERS

DATE CONSIDERED

4/9/03

*EXAMINER

Initial if citation considered, whether or not citation is in conformance with MPEP 609 Draw line through citation if not in conformance and not considered. Include a copy of this form with next communication to Applicant.